1. Disassembly Procedures

S1 Turn off the monitor.

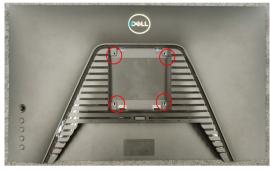
Place the monitor on a soft cloth or **S2** cushion

Press and hold the stand release button

Lift the stand up and away from the monitor



Unlock 4 RC screws **S3**



(Screw Torque: 8~10kgf)

Use hands or scraper bar to **S4** disassemble Rear Cover from monitor

Notice the disassembly order:

Top Side=>Right/ Left Side=>Bottom Side



Remove CTRL BD FFC wire from I/F **S5** BD and remove all tapes from panel

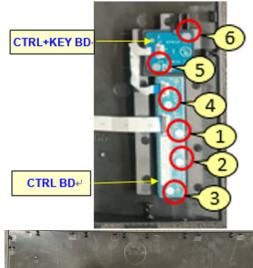


Unlock 6 CTRL BD screws **S6**

Remove tapes from Rear Cover

Disassemble CTRLB and CTRL + KEY **BD** from Rear Cover

Remove CTRL BD FFC wire and CTRL + KEY BD FFC wire from CTRL BD and CTRL+KEY BD

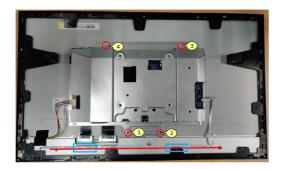




(Screw Torque: 0.95~1.05kgf)

Remove PWR BTN BD FFC wire from I/F BD

Unlock 4 screws on Main SHD



(Screw Torque: 4.5±0.5kgf)

S8 Unlock 5 Trim screws



(Screw Torque: 1~1.1kgf)

Remove backlight wire from SPS BD and remove all tapes from panel

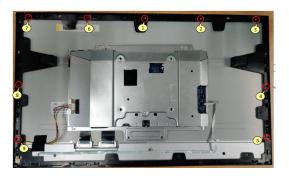
Remove AL foil and yellow tape from panel

Remove two LVDS FFC cable from panel





S10 Unlock 9 MF screws



(Screw Torque: 7.0±0.5kgf)

S11 Disassemble Middle Frame and "BZL CHIN" from panel









S12 Unlock 2 screws from Middle Frame

Disassemble PWR BTN from Middle Frame



(Screw Torque: 1~1.1kgf)

S13 Unlock 2 screws from PWR BTN

Disassemble PWR BTN BD from PWR BTN



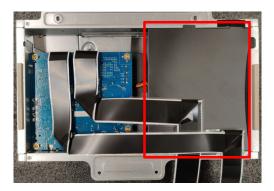
(Screw Torque: 0.95~1.05kgf)

S14 Tear off 1 tape on the connector of backlight wire

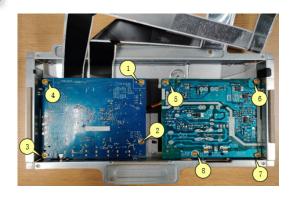
Remove Backlight wire from panel



S15 Remove Mylar from SPS BD



S16 Unlock 8 PCBA screws



(Screw Torque: 8.5±1.0kgf)

S17 Disassemble I/F BD from Main SHD and remove SPS BD wire from I/F BD

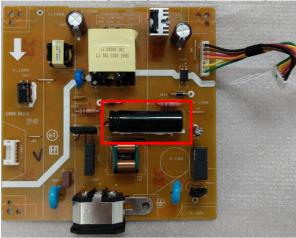
Remove two LVDS FFC cable from I/F BD

Disassemble SPS BD from Main SHD

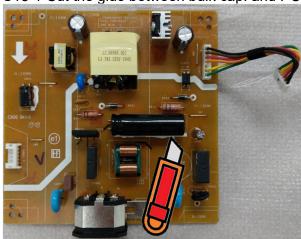




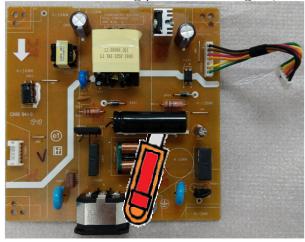
S18 Remove electrolyte capacitors (red mark) from printed circuit boards



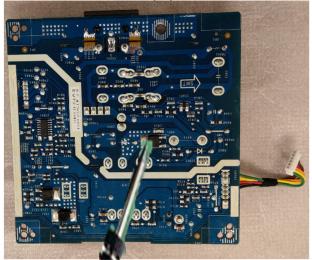
S18-1 Cut the glue between bulk cap. and PCB with a knife



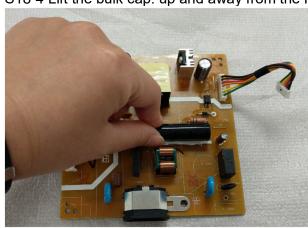
S18-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB



S18-3 Take out bulk cap. pin solder with soldering iron and absorber



S18-4 Lift the bulk cap. up and away from the PCB



2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

| Capacitors / condensers (containing PCB/PCT) | No used |
|--|--|
| Mercury containing components | No used |
| Batteries | No used |
| Printed circuit boards (with a surface greater | Product has printed circuit boards |
| than 10 square cm) | (with a surface greater than 10 square |
| | cm) |
| Component contain toner, ink and liquids | No used |
| Plastic containing BFR | No used |
| Component and waste contain asbestos | No used |
| CRT | No used |
| Component contain CFC, HCFC, HFC and | No used |
| HC | |
| Gas discharge lamps | No used |
| LCD display > 100 cm2 | Product has an LCD greater than 100 |
| | cm2 |
| External electric cable | Product has external cables |
| Component contain refractory ceramic fibers | No used |
| Component contain radio-active substances | No used |
| Electrolyte capacitors (height | Product has electrolyte capacitors |
| > 25mm, diameter > 25mm) | (height >25mm, diameter > 25mm) |

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Scraper Bar
- Penknife
- Soldering iron and absorber